

A micrograph of a silicon die with a grid overlay. The die is rectangular and contains various circuit patterns. A grid of thin lines is overlaid on the die. In the bottom-left corner, there is text identifying the vendor, product, version, and metal layer. A scale bar is located at the bottom center.

& Vendor GLOBALFOUNDRIES

& Product GF018HV5V_green_sc0

& Version 001502v2

& Metal0 1.00

2 μ m